

20 V, 6.2 A PNP low VCEsat transistor

9 January 2025

Product data sheet

1. General description

PNP low V_{CEsat} transistor in a medium power and flat lead SOT89 (SC-62) Surface-Mounted Device (SMD) plastic package.

NPN complement: PBSS4021NX-Q

2. Features and benefits

- Very low collector-emitter saturation voltage V_{CEsat}
- High collector current capability I_C and I_{CM}
- High collector current gain (h_{FE}) at high I_C
- High energy efficiency due to less heat generation
- · Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- Loadswitch
 - Battery-driven devices
- Power management
- Charging circuits
- Power switches (e.g. motors, fans)

4. Quick reference data

Table 1. Quick reference data							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{CEO}	collector-emitter voltage	open base		-	-	-20	V
I _C	collector current			-	-	-6.2	А
I _{CM}	peak collector current	single pulse; t _p ≤ 1 ms		-	-	-15	А
R _{CEsat}	collector-emitter saturation resistance	I_C = -4 A; I_B = -400 mA; pulsed; $t_p \le$ 300 μs; δ ≤ 0.02; T_{amb} = 25 °C		-	23	38	mΩ

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	E	emitter		С
2	С	collector		в
3	В	base		5 hr E
			SOT89	006aaa231



6. Ordering information

Table 3. Ordering information					
Type number Package					
	Name	Description	Version		
PBSS4021PX-Q		plastic, surface-mounted package; 3 leads; 1.5 mm pitch; 4.5 mm x 2.5 mm x 1.5 mm body	<u>SOT89</u>		

7. Marking

Table 4. Marking codes	
Type number	Marking code[1]
PBSS4021PX-Q	%6E

[1] % = placeholder for manufacturing site code

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

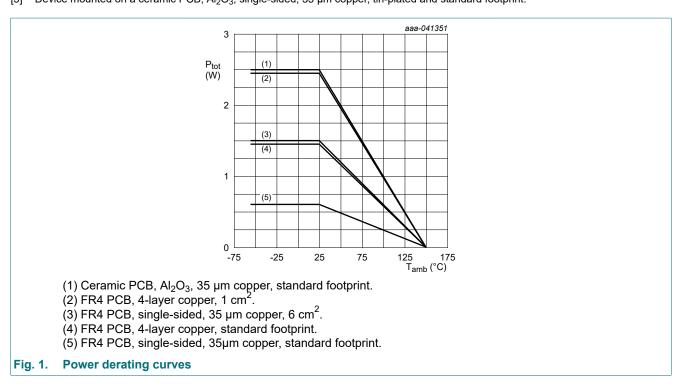
Symbol	Parameter	Conditions		Min	Max	Unit
V _{CBO}	collector-base voltage	open emitter		-	-20	V
V _{CEO}	collector-emitter voltage	open base		-	-20	V
V _{EBO}	emitter-base voltage	open collector		-	-5	V
l _C	collector current			-	-6.2	А
I _{CM}	peak collector current	single pulse; t _p ≤ 1 ms		-	-15	А
I _B	base current			-	-1	А
P _{tot} total pow	total power dissipation	dissipation $T_{amb} \le 25 \degree C$	[1]	-	600	mW
			[2]	-	1.5	W
			[3]	-	1.45	W
			[4]	-	2.45	W
			[5]	-	2.5	W
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided, 35 µm copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided, 35 µm copper, tin-plated, mounting pad for collector 6 cm².

[3] Device mounted on an FR4 PCB, 4-layer, tin-plated and standard footprint.

[4] Device mounted on an FR4 PCB, 4-layer, tin-plated, mounting pad for collector 1 cm².
 [5] Device mounted on a ceramic PCB, Al₂O₃, single-sided, 35 µm copper, tin-plated and standard footprint.



9. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
R _{th(j-a)} thermal resistance fro junction to ambient		nction to ambient	[1]	-	-	208	K/W
	junction to ambient		[2]	-	-	83	K/W
			[3]	-	-	86	K/W
			[4]	-	-	51	K/W
			[5]	-	-	50	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point			-	-	20	K/W

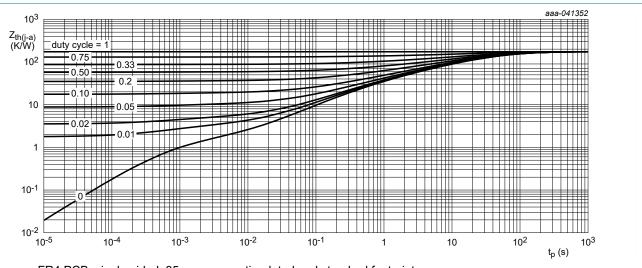
[1] Device mounted on an FR4 PCB, single-sided, 35 µm copper, tin-plated and standard footprint.

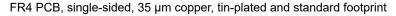
[2] Device mounted on an FR4 PCB, single-sided, 35 µm copper, tin-plated, mounting pad for collector 6 cm².

[3] Device mounted on an FR4 PCB, 4-layer, tin-plated and standard footprint.

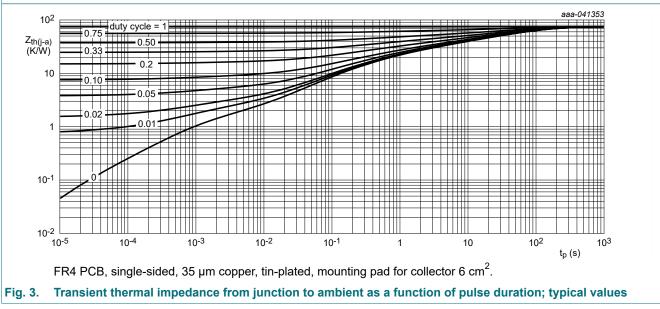
[4] Device mounted on an FR4 PCB, 4-layer, tin-plated, mounting pad for collector 1 cm².

[5] Device mounted on a ceramic PCB, Al₂O₃, single-sided, 35 µm copper, tin-plated and standard footprint.



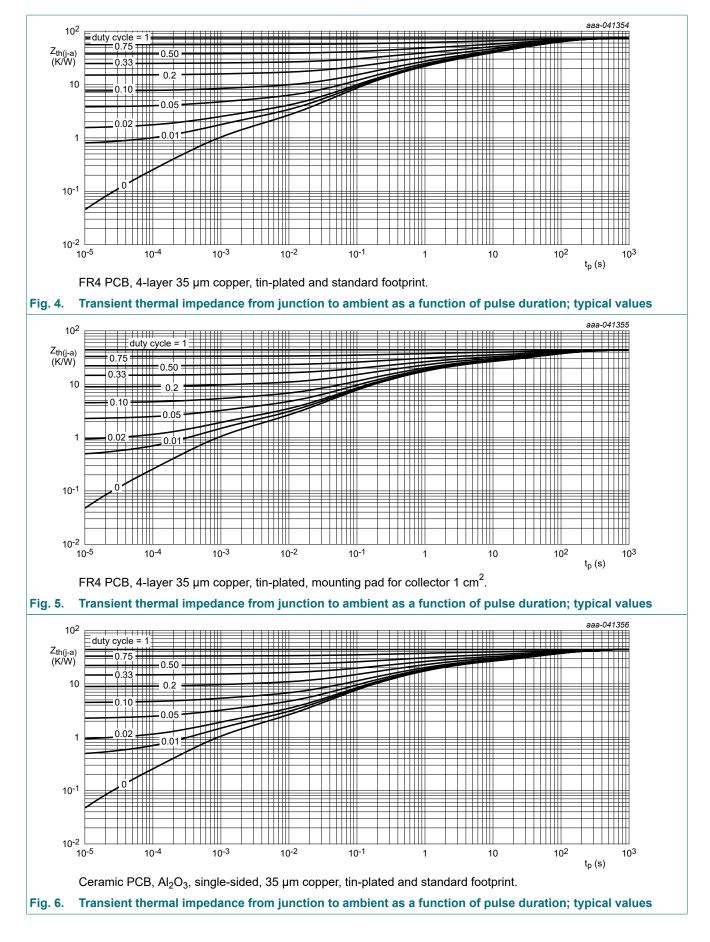








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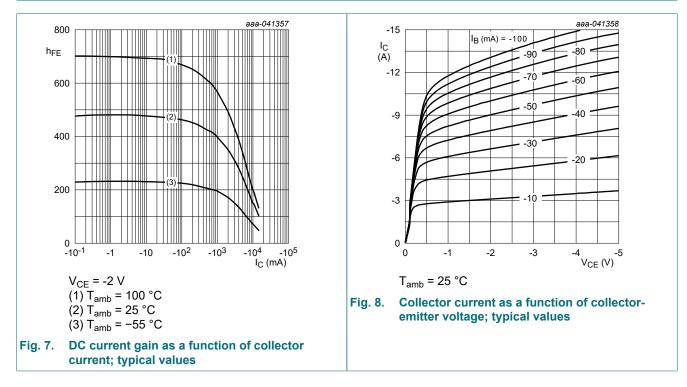


10. Characteristics

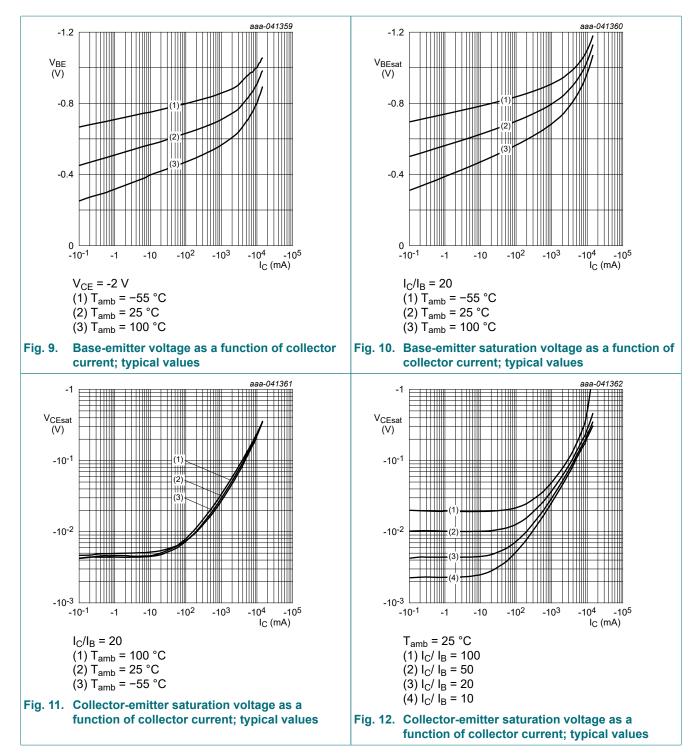
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{(BR)CBO}	collector-base breakdown voltage	I _C = -100 μA; I _E = 0 A; T _{amb} = 25 °C	-20	-	-	V
V _{(BR)CEO}	collector-emitter breakdown voltage	I _C = -10 mA; I _B = 0 A; T _{amb} = 25 °C	-20	-	-	V
V _{(BR)EBO}	emitter-base breakdown voltage	I _E = -100 μA; I _C = 0 A; T _{amb} = 25 °C	-5	-	-	V
I _{сво}	collector-base cut-off	V _{CB} = -20 V; I _E = 0 A; T _{amb} = 25 °C	-	-	-100	nA
	current	V _{CB} = -20 V; I _E = 0 A; T _j = 150 °C	-	-	-50	μA
I _{CES}	collector-emitter cut-off current	V_{CE} = -16 V; V_{BE} = 0 V; T_{amb} = 25 °C	-	-	-100	nA
I _{EBO}	emitter-base cut-off current	V _{EB} = -5 V; I _C = 0 A; T _{amb} = 25 °C	-	-	-100	nA
h _{FE}	DC current gain	V_{CE} = -2 V; I _C = -0.5 A; pulsed; t _p ≤ 300 μs; δ ≤ 0.02; T _{amb} = 25 °C	250	425	-	
		V_{CE} = -2 V; I _C = -1 A; pulsed; t _p ≤ 300 μs; δ ≤ 0.02; T _{amb} = 25 °C	250	405	-	
		V_{CE} = -2 V; I _C = -2 A; pulsed; t _p ≤ 300 μs; δ ≤ 0.02; T _{amb} = 25 °C	200	355	-	
		V_{CE} = -2 V; I _C = -4 A; pulsed; t _p ≤ 300 μs; δ ≤ 0.02; T _{amb} = 25 °C	150	290	-	
		V_{CE} = -2 V; I _C = -7 A; pulsed; t _p ≤ 300 μs; δ ≤ 0.02; T _{amb} = 25 °C	80	210	-	
0204	collector-emitter saturation voltage	I_C = -1 A; I_B = -10 mA; pulsed; t_p ≤ 300 μs; δ ≤ 0.02; T_{amb} = 25 °C	-	-50	-90	mV
		I _C = -1 A; I _B = -50 mA; pulsed; t _p ≤ 300 μs; δ ≤ 0.02; T _{amb} = 25 °C	-	-30	-50	mV
		I_{C} = -2 A; I_{B} = -40 mA; pulsed; t_{p} ≤ 300 μs; δ ≤ 0.02; T_{amb} = 25 °C	-	-60	-110	mV
		I_{C} = -4 A; I_{B} = -40 mA; pulsed; t_{p} ≤ 300 μs; δ ≤ 0.02; T_{amb} = 25 °C	-	-130	-270	mV
		I_{C} = -4 A; I_{B} = -200 mA; pulsed; t_{p} ≤ 300 μs; δ ≤ 0.02; T_{amb} = 25 °C	-	-90	-160	mV
		I_{C} = -6.9 A; I_{B} = -345 mA; pulsed; t_{p} ≤ 300 μs; δ ≤ 0.02; T_{amb} = 25 °C	-	-160	-265	mV
R _{CEsat}	collector-emitter saturation resistance	I_{C} = -4 A; I_{B} = -400 mA; pulsed; t_{p} ≤ 300 μs; δ ≤ 0.02; T_{amb} = 25 °C	-	23	38	mΩ
V _{BEsat}	base-emitter saturation voltage	I_{C} = -1 A; I_{B} = -100 mA; pulsed; t_{p} ≤ 300 μs; δ ≤ 0.02; T_{amb} = 25 °C	-	-0.82	-0.9	V
		I_{C} = -4 A; I_{B} = -400 mA; pulsed; t_{p} ≤ 300 μs; δ ≤ 0.02; T_{amb} = 25 °C	-	-0.93	-1.05	V
V _{BEon}	base-emitter turn-on voltage	V _{CE} = -2 V; I _C = -2 A; pulsed; t _p ≤ 300 μs; δ ≤ 0.02; T _{amb} = 25 °C	-	-0.74	-0.85	V

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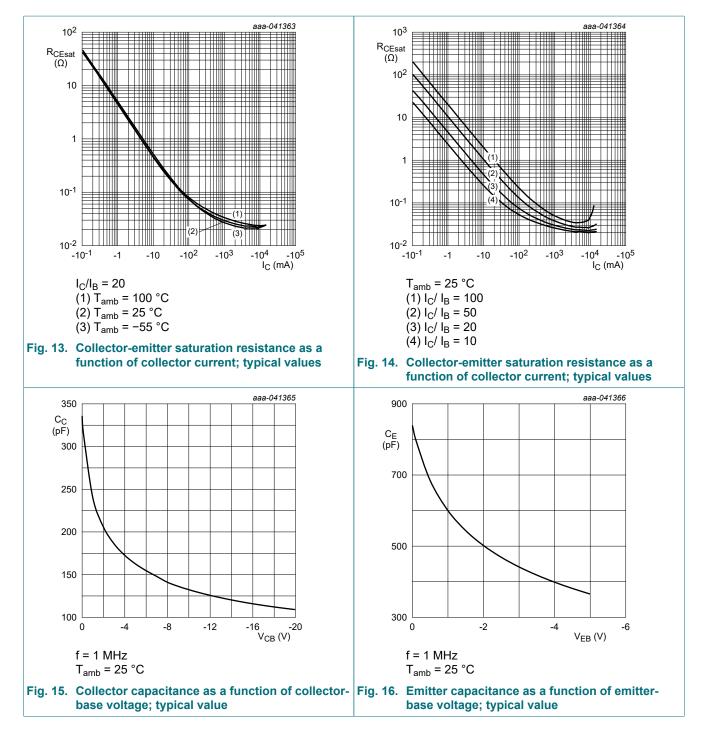
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t _d	delay time	$V_{CC} = -12.5 \text{ V}; \text{ I}_{C} = -1 \text{ A}; \text{ I}_{Bon} = -50 \text{ mA};$ $\text{I}_{Boff} = 50 \text{ mA}; \text{ T}_{amb} = 25 \text{ °C}$	-	43	-	ns
t _r	rise time		-	50	-	ns
t _{on}	turn-on time		-	93	-	ns
t _s	storage time		-	347	-	ns
t _f	fall time		-	87	-	ns
t _{off}	turn-off time		-	434	-	ns
f _T	transition frequency	V_{CE} = -10 V; I _C = -100 mA; f = 100 MHz; T _{amb} = 25 °C	-	91	-	MHz
C _c	collector capacitance	V _{CB} = -10 V; I _E = 0 A; i _e = 0 A; f = 1 MHz; T _{amb} = 25 °C	-	129	-	pF



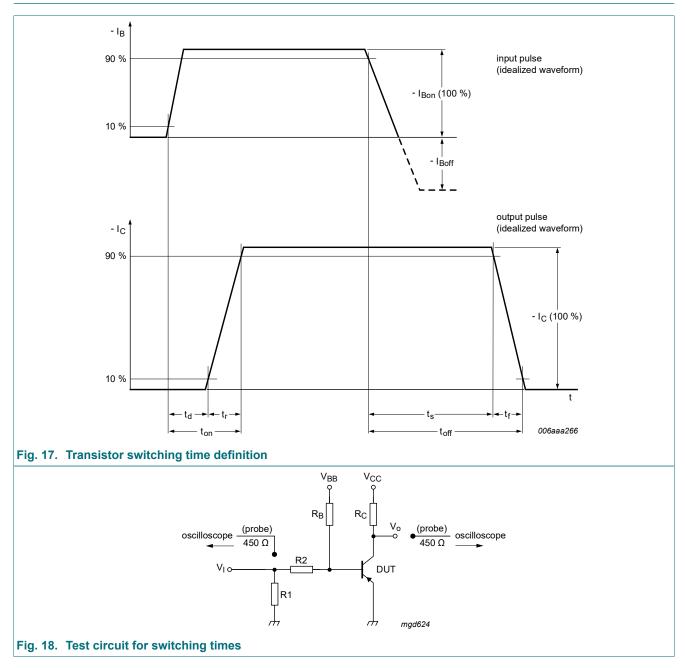
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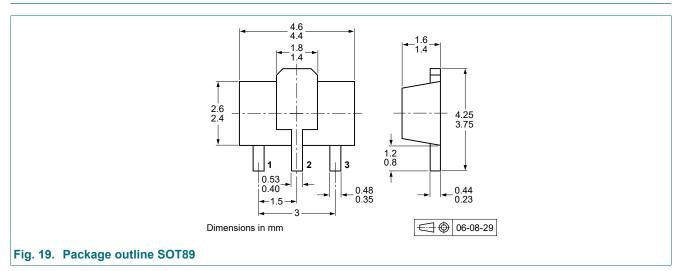
11. Test information



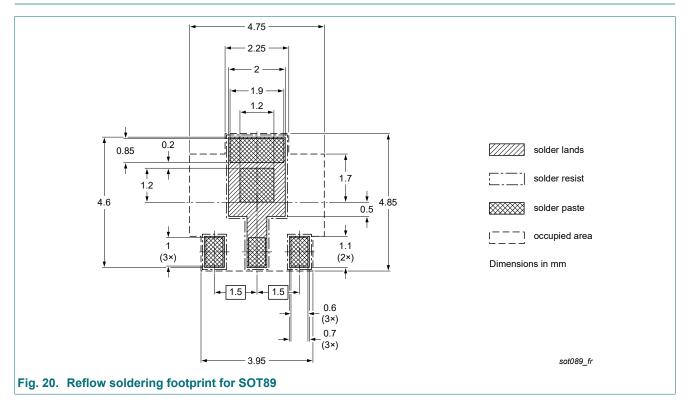
Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

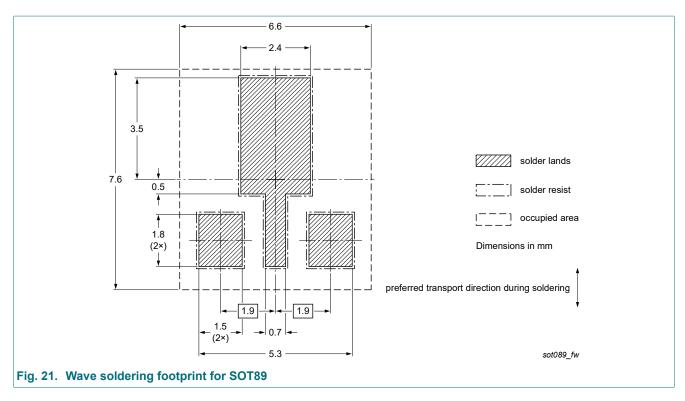
12. Package outline



13. Soldering



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14. Revision history

Table 8. Revision history							
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes			
PBSS4021PX-Q v.2	20250109	Product data sheet	-	PBSS4021PX-Q v.1			
Modifications:	New graphics and va	New graphics and values are added.					
PBSS4021PX-Q v.1	20240105	Product data sheet	-	-			

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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